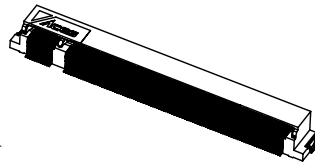
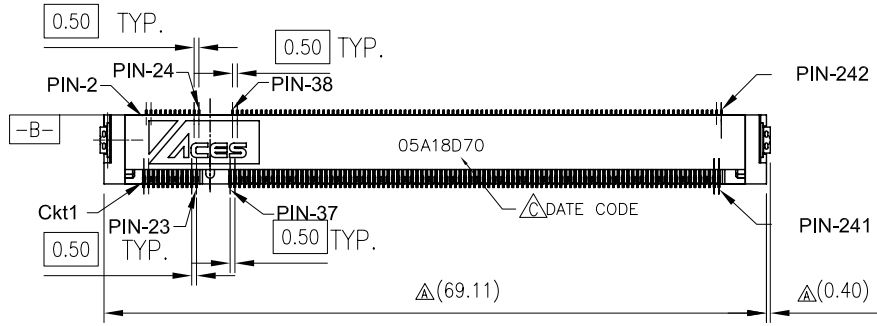


A B C D E F



NOTES:

- MATERIAL:
 - HOUSING: THERMOPLASTIC, HIGH TEMP., UL94V-0; COLOR:NATURAL.
 - CONTACT: COPPER ALLOY
 - FITTING NAIL: COPPER ALLOY
- FINISH:
 - CONTACT:
 - UNDERPLATING: 30u"~80u" MIN. NICKEL OVERALL.
 - FINISH: 8:GOLD FLASH OVER ALL
 - GOLD 3u" MIN. ON CONTACT
 - M:GOLD 3u" MIN. ON CONTACT AND SOLDER FOR SELECTIVENESS
 - FITTING NAIL:
 - UNDERPLATING: 30u"~80u" MIN. NICKEL OVERALL.
 - FINISH: 8:GOLD FLASH OVER ALL
 - GOLD 3u" MIN. ON CONTACT
 - M:GOLD 3u" MIN. ON CONTACT AND SOLDER FOR SELECTIVENESS
- REFLOW SOLDER CAPABLE TO 260°C PER ACES SPEC.
- ROHS COMPLIANT PRODUCT.
- SPEC. PLS. REFER TO PS-88881-xxxxx
- DRAWING PACKAGING REFER TO 88883-xxxx
- PART NUMBER

1

2

3

4

5

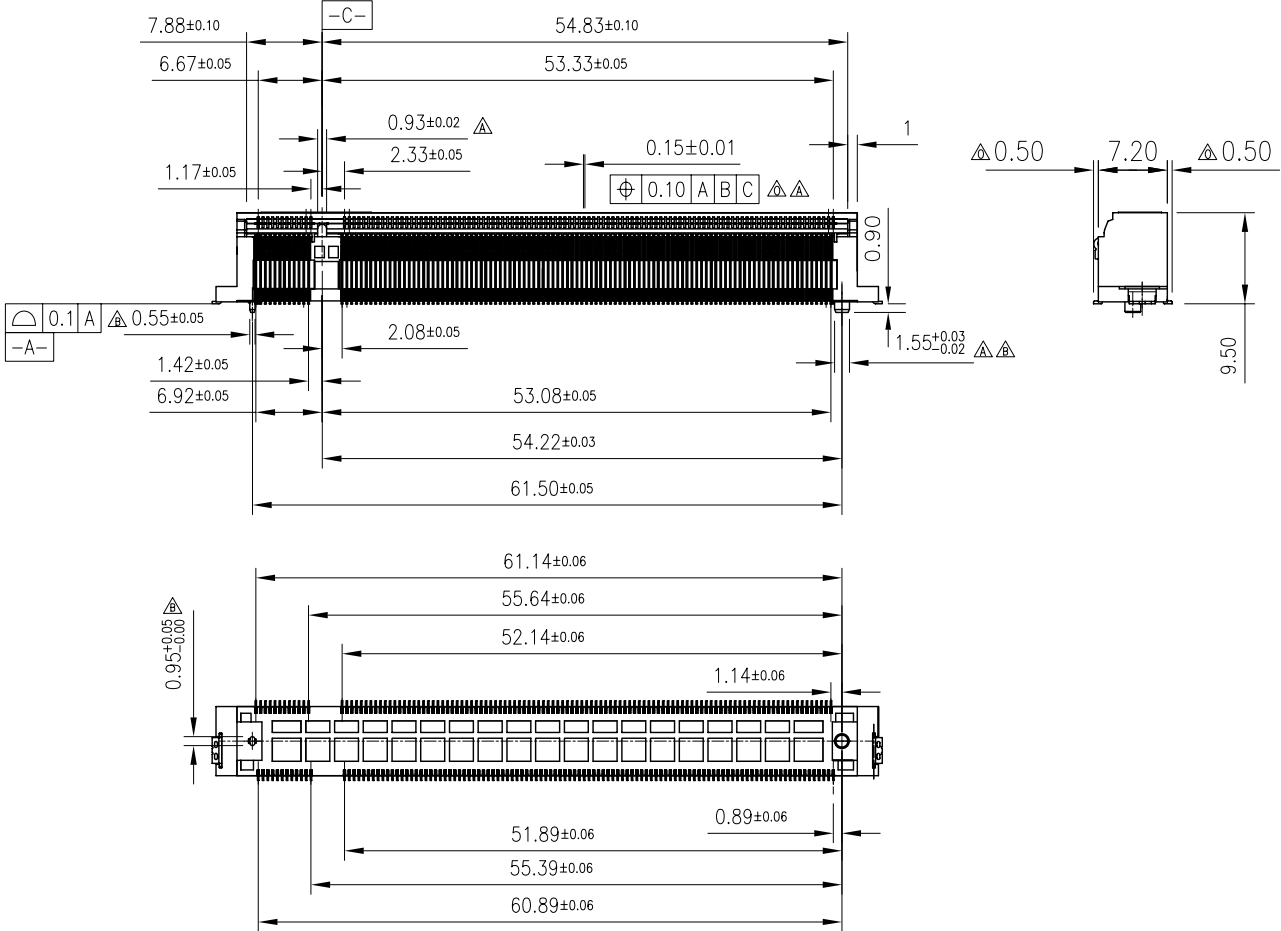
1

2

3

4

5



88883-2D X X

NO OF CKT — PLATING
230 CKTS — 8: G/F OVER ALL(LEAD FREE)
GOLD 3u" MIN. ON CONTACT

PACKING — M:GOLD 3u" MIN. ON CONTACT
AND SOLDER FOR SELECTIVENESS

0:Tape & Reel
2:Tray

REV	DESCRIPTION	DATE	SIGNATURE
C	修改DATE CODE編碼—ECN—0810008	08' / 11 / 08	Bernie
B	增加底部視圖/修改BOSS,降低Shift量ECN—0803026	08' / 03 / 02	Bernie
A	產品尺寸加標/尺寸修改ECN—'0703121	07' / 05 / 20	Bernie
O	RELEASE ECN—ADR95018	06' / 06 / 28	Bernie

一般公差 TOLERANCES X ±0.5 XX ±0.15 Y ±0.25 .XXX ±0.1 ANGLES ±2°		宏致電子股份有限公司 Aces Electronic Co.,Ltd.	
檢驗尺寸標示 SYMBOLS ⊕ ⊗ INDICATE CLASSIFICATION DIMENSION ⊕ MARK IS CRITICAL DIM. ⊗ MARK IS MAJOR DIM.	品名 (TITLE) MXM 230 pins 0.5mm pitch Edge Card Conn. R/A D/R SID H=9.5mm (BIT H=7.0)	製圖 (DR) 06' / 03 / 20 審核 (CHKD) Warles	Bernie
表面處理 (FINISH)	圖號 (DWG.NO) 88883-2DXX	核准 (APPD) JASON	張數 (SHEET) 1 OF 3
比例 (SCALE) 1.5:1	單位 (UNITS) mm	張數 (SHEET) 1 OF 3	尺寸 (SIZE) A4
日期 (DATE)	申請人 (SIGNATURE)	尺寸 (SIZE) A4	版本 (REV) C

A B C D E F

